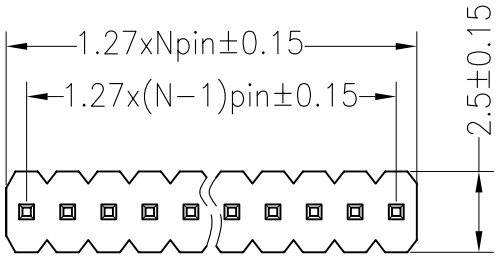
HSF RoHS

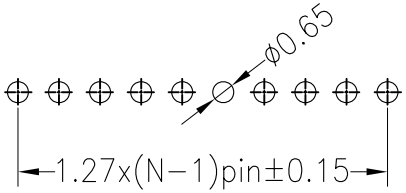
FILE NO :E362810

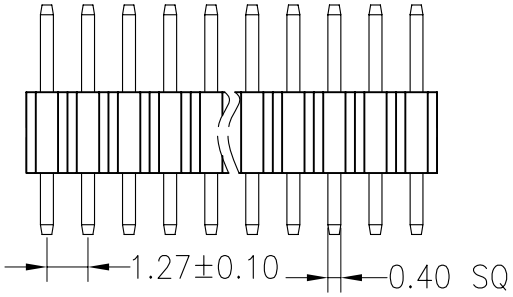
SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

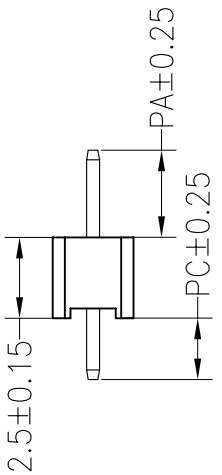
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

1425 11 XX X N XX S XXX X 0X

No.of Pins Per Row	Insulator Material	Contact Plating	Pin Length	Packing	code stream
01~50P	Option A=BK−PBT B=BK−PA66 C=BK−PA6T D=BK−PA46 F=BK−LCP	G0:0.8U" Gold G1:1U" Gold G2:1.5U" Gold G3:2U" Gold G4:3U" Gold G5:5U" Gold G6:10U" Gold G7:15U" Gold S0:Gold Flash/Tin SN:Tin		0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar	01~99

Dimension antitheses list			
ITEM	PA	PC	L
Alternate	3.00	2.30	7.80

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.03.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	12.03.28
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	142511XXXNXXSXXXX0X
TITLE:	1.27PH H2.5mm 1xNpin DIP